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50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

General Description

The MAX22506E ESD-protected RS-485/RS-422 transceiver is optimized for high-speed communication up to 50Mbps. This transceiver features integrated hot-swap protection and a fail-safe receiver, ensuring a logic-high on the receiver output when input signals are shorted or open for longer than 10 μ s (typ). Additionally, a large receiver hysteresis improves noise rejection and signal integrity.

The MAX22506E is designed to operate in harsh industrial environments and is optimized for robust communication in environments with high levels of electromagnetic interference (EMI).

The MAX22506E is available in an 8-pin SOIC and an 8-pin μ MAX package. The transceiver operates over the -40°C to +125°C temperature range.

Applications

- Motion Control
- Encoder Interfaces
- Field Bus Networks
- Industrial Control Systems
- Backplane Busses

Benefits and Features

- High-Speed Operation over Long Distances
 - Up to 50Mbps Data Rate
 - High Receiver Sensitivity
 - Wide Receiver Bandwidth
 - Symmetrical Receiver Thresholds
- Integrated Protection Increases Robustness
 - -15V to +15V Common-Mode Range
 - ±15kV ESD Protection (Human Body Model)
 - ±7kV IEC 61000-4-2 Air-Gap ESD Protection
 - ±6kV IEC 61000-4-2 Contact Discharge ESD Protection
 - Withstands Over ±4kV EFT
 - · Driver Outputs are Short-Circuit Protected
- Flexibility for Many Different Applications
 - 3V to 5.5V Supply Range
 - Low 5µA (max) Shutdown Current
 - Available in 8-pin SOIC and µMAX Packages
 - -40°C to +125°C Operating Temperature Range

Simplified Block Diagram



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50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

TABLE OF CONTENTS

General Description
Applications
Benefits and Features
Simplified Block Diagram
Absolute Maximum Ratings
Package Information
μMAX8
SOIC8
Electrical Characteristics
Typical Operating Characteristics
Pin Configuration
MAX22506E
Pin Description
Function Tables
Transmitting Table
Receiving Table
Detailed Description
Receiver Threshold Voltages
Fail-Safe Functionality 14
Driver Single-Ended Operation
Hot-Swap Inputs
Driver Output Protection
Low-Power Shutdown Mode
Integrated ESD Protection
Human Body Model (HBM)
IEC 61000-4-2
Applications Information
Transceivers on the Bus
Transient Protection
External ESD Protection
Electrical Fast Transient (EFT) Events 17
Surge Protection
Layout Guidelines
Typical Application Circuits
Half Duplex Point-to-Point Network 19
Ordering Information
Revision History

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

LIST OF FIGURES

7
8
8
8
9
9
9
0
5
5
6
6
8

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Absolute Maximum Ratings

V _{CC}		-0.3V to +6V	8-Pin SOIC (derate 7.4mW/°
RE, DE, DI		-0.3V to +6V	Operating Temperature Range
RO	0.3V to	(V _{CC} + 0.3V)	Junction Temperature
А, В		-15V to +15V	Storage Temperature Range
Short-Circuit Dura	tion (RO, A, B) to GND	Continuous	Lead Temperature (soldering 1
Continuous Powe	T Dissipation ($T_A = +70^{\circ}C$)		Reflow Temperature
8-Pin uMAX (de	$rate 1.8 m W/^{\circ}C above +70^{\circ}C$	387 8m\//	

8-Pin SOIC (derate 7.4mW/°C above +70°C).	588.2mW
Operating Temperature Range	-40°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering 10s)	+300°C
Reflow Temperature	+270°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Information

µMAX8

Package Code	U8+1				
Outline Number	<u>21-0036</u>				
Land Pattern Number	<u>90-0092</u>				
THERMAL RESISTANCE, FOUR-LAYER BOARD					
Junction to Ambient (θ _{JA})	206.3°C/W				
Junction to Case (θ_{JC})	42°C/W				

SOIC8

Package Code	S8+2C				
Outline Number	<u>21-0041</u>				
Land Pattern Number	<u>90-0096</u>				
THERMAL RESISTANCE, FOUR-LAYER BOARD					
Junction to Ambient (θ_{JA})	136°C/W				
Junction to Case (θ_{JC})	38°C/W				

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <u>www.maximintegrated.com/</u> <u>thermal-tutorial</u>.

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Electrical Characteristics

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DC ELECTRICAL CHARA	ACTERISTICS /	POWER					
Supply Voltage	V _{CC}					5.5	V
Supply Current	I _{CC}	DE = high, \overline{RE} = low	r, no load		4	5.6	mA
Shutdown Supply Current	I _{SHDN}	DE = low, \overline{RE} = high	I			5	μA
DC ELECTRICAL CHARA	ACTERISTICS /	DRIVER	-				
Differential Driver Output	V _{OD}	Figure 1	R _L = 54Ω R _L = 100Ω	1.5 2.0			v
Change in Magnitude of Differential Output Voltage	ΔV _{OD}	$R_L = 54\Omega, Figure 1$	(Note 3)			0.2	v
Driver Common-Mode Output Voltage	V _{OC}	R _L = 54Ω, <u>Figure 1</u>			V _{CC} / 2	3	V
Change in Magnitude of Common-Mode Voltage	ΔV _{OC}	R _L = 100Ω or 54Ω, <u>I</u>	Figure 1 (Note 3)			0.2	V
Single-Ended Driver Output High	V _{OH}	A or B output, I _{OUT}	= -20mA	2.2			V
Single-Ended Driver Output Low	V _{OL}	A or B output, I _{OUT}	= +20mA			0.8	V
Differential Output Capacitance	C _{OD}	DE = high, f = 4MHz	DE = high, f = 4MHz		50		pF
Driver Short-Circuit Output Current	I _{OST}	$-15V \le V_{OUT} \le +15V$	/			250	mA
DC ELECTRICAL CHARA	ACTERISTICS /	RECEIVER					
		DE = low,	V _{IN} = +12V			+390	
Input Current (A and B)	I _{A,B}	$V_{CC} = 0V \text{ or}$ $3V \le V_{CC} \le 5.5V$	V _{IN} = -7V	-360			μΑ
Differential Input Capacitance	C _{A,B}	Between A and B, f	= 2MHz		50		pF
Common-Mode Voltage Range	V _{CM}			-15		+15	V
Receiver Differential- Threshold High	V _{TH_H}	$-15V \le V_{CM} \le +15V$		+50	+122	+200	mV
Receiver Differential- Threshold Low	V _{TH_L}	$-15V \le V_{CM} \le +15V$		-200	-122	-50	mV
Receiver Input Hysteresis	ΔV_{TH}	is < t _{D_FS}	V_{CM} = 0V, time from last transition is < t_{D_FS}		250		mV
Differential Input Fail-Safe Level	V _{TH_FS}	$-15V \le V_{CM} \le +15V_{T}$ transition > t _{F_DS}	, time from last	-50		+50	mV
DC ELECTRICAL CHARA	ACTERISTICS /	LOGIC INTERFACE	RE, RO, DE, DI)				
Input-Voltage High	VIH	DE, DI, RE	$3V \le V_{CC} \le 5.5V$	2/3 x V _{CC}			V
			V _{CC} = 5.25V	2.85			
Input-Voltage Low	VIL	DE, DI, RE				1/3 x V _{CC}	V

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Electrical Characteristics (continued)

(V_{CC} = 3V to 5.5V, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at V_{CC} = 3.3V and $T_A = +25^{\circ}$ C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Input Current	I _{IN}	DE, DI, RE (after first transition)	-2		+2	μA	
Input Impedance on First Transition	R _{IN_FT}	DE, RE			10	kΩ	
RO Output-High Voltage	V _{OH}	$\overline{\text{RE}}$ = low, (V _A - V _B) > 200mV, I _{OUT} = -1mA	V _{CC} – 0.4			V	
RO Output-Low Voltage	V _{OL}	$\overline{\text{RE}}$ = low, (V _A –V _B) < -200mV, I _{OUT} = +1mA			0.4	V	
Three-State Output Current at Receiver	I _{OZR}	$\overline{\text{RE}}$ = high, $0 \le V_{\text{RO}} \le V_{\text{CC}}$	-1		+1	μA	
PROTECTION							
Thermal-Shutdown Threshold	T _{SH}	Temperature rising		+160		°C	
Thermal-Shutdown Hysteresis	T _{SH_HYS}			10		°C	
		Human Body Model		±15			
ESD Protection (A and B Pins)		IEC61000-4-2 Air Gap Discharge to GND		±7		kV	
(, , , , , , , , , , , , , , , , , , ,		IEC61000-4-2 Contact Discharge to GND		±6			
ESD Protection (All Other Pins)		Human Body Model		±2		kV	
AC ELECTRICAL CHAR	ACTERISTICS /	DRIVER (Note 4)					
Driver Propagation	t _{DPLH}	$R_L = 54\Omega$, $C_L = 50pF$, Figure 2, Figure 3			32	32 32 ns	
Delay	t _{DPHL}	$R_L = 54\Omega, C_L = 50pF, Figure 2, Figure 3$			32		
Differential-Driver Output Skew	t _{DSKEW}	$ t_{DPLH} - t_{DPHL} $, R _L = 54 Ω , C _L = 50pF, Figure 2, Figure 3 (Note 5)			1.2	ns	
Driver Differential- Output Rise and Fall Time	t _{HL} , t _{LH}	$R_L = 54\Omega, C_L = 50pF, Figure 3$ (Note 5)			3	ns	
Maximum Data Rate	DR		50			Mbps	
Driver Enable to Output High	t _{DZH}	$R_L = 500\Omega, C_L = 50pF, Figure 4$			32	ns	
Driver Enable to Output Low	t _{DZL}	R_L = 500Ω, C_L = 50pF, <u>Figure 5</u>			32	ns	
Driver Disable Time from High	t _{DHZ}	$R_L = 500\Omega, C_L = 50pF, Figure 4$			32	ns	
Driver Disable Time from Low	t _{DLZ}	R_L = 500Ω, C_L = 50pF, <u>Figure 5</u>			32	ns	
Driver Enable from Shutdown to Output High	^t DZH(SHDN)	$R_L = 1k\Omega, C_L = 15pF, Figure 4$			100	μs	
Driver Enable from Shutdown to Output Low	t _{DZL(SHDN)}	$R_L = 1k\Omega, C_L = 15pF, Figure 5$			100	μs	
Time to Shutdown	t _{SHDN}	(Notes 6, 7)	50		800	ns	

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Electrical Characteristics (continued)

(V_{CC} = 3V to 5.5V, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $V_{CC} = 3.3V$ and $T_A = +25^{\circ}C$.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
AC ELECTRICAL CHARACTERISTICS / RECEIVER (Note 4)							
Delay to Fail-Safe Operation	^t D_FS			10		μs	
Receiver Propagation Delay	t _{RPLH} , t _{RPHL}	C _L = 15pF, <u>Figures 6, 7</u>			40	ns	
Receiver Output Skew	^t RSKEW	t _{RPHL} - t _{RPLH} , C _L = 15pF, <u><i>Figures 6</i>, 7</u> (Note 5)			2.5	ns	
Maximum Data Rate	DR		50			Mbps	
Receiver Enable to Output High	^t RZH	$R_L = 1k\Omega$, $C_L = 15pF$, Figure 8			32	ns	
Receiver Enable to Output Low	t _{RZL}	$R_L = 1k\Omega, C_L = 15pF, Figure 8$			32	ns	
Receiver Disable Time from Low	t _{RLZ}	$R_L = 1k\Omega, C_L = 15pF, Figure 8$			32	ns	
Receiver Disable Time from High	^t RHZ	$R_L = 1k\Omega, C_L = 15pF, Figure 8$			32	ns	
Receiver Enable from Shutdown to Output High	^t RZH(SHDN)	R _L = 1kΩ, C _L = 15pF, <u>Figure 8</u>			100	μs	
Receiver Enable from Shutdown to Output Low	^t RZL(SHDN)	R _L = 1kΩ, C _L = 15pF, <u>Figure 8</u>			100	μs	
Time to Shutdown	^t SHDN	(Notes 6, 7)	50		800	ns	

Note 1: All devices are 100% production tested at $T_A = +25^{\circ}C$. Specifications for all temperature limits are guaranteed by design.

Note 2: All currents into the device are positive. All currents out of the device are negative. All voltages are referenced to the device ground, unless otherwise noted.

Note 3: ΔV_{OD} and ΔV_{OC} are the changes in V_{OD} and V_{OC} , respectively, when the DI input changes state.

Note 4: Capacitive load includes test probe and fixture capacitance.

Note 5: Not production tested. Guaranteed by design.

Note 6: Shutdown is enabled by driving RE high and DE low. The device is guaranteed to have entered shutdown after t_{SHDN} has elapsed.

Note 7: Time to shutdown refers to the driver or receiver enable delay when the device has exited the initial hot-swap protect state and is in normal operating mode.



Figure 1. Driver DC Test Load

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity



Figure 2. Driver Timing Test Circuit



Figure 3. Driver Propagation Delays



Figure 4. Driver Enable and Disable Times (t_{DZH}, t_{DHZ})

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity



Figure 5. Driver Enable and Disable Times (t_{DZL}, t_{DLZ})



Figure 6. Receiver Propagation Delay Test Circuit



Figure 7. Receiver Propagation Delays

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity



Figure 8. Receiver Enable and Disable Times

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Typical Operating Characteristics

 $(V_{CC} = 5V, 60\Omega \text{ termination between the driver outputs}, T_A = 25^{\circ}C, \text{ unless otherwise noted.})$



50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Typical Operating Characteristics (continued)

 $(V_{CC} = 5V, 60\Omega \text{ termination between the driver outputs}, T_A = 25^{\circ}C, \text{ unless otherwise noted.})$









Pin Configuration

MAX22506E



50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Pin Description

PIN	NAME	FUNCTION			
1	RO	eceiver Output. See the <u>Receiving Table</u> for more information.			
2	RE	ceiver Enable. Pull \overline{RE} high to disable the receiver and three-state RO. The device is in low-ver shutdown when \overline{RE} = high and DE = low.			
3	DE	Driver Output Enable. Force DE high to enable the driver. The device is in low-power shutdown when \overline{RE} = high and DE = low.			
4	DI	Driver Input. See the Transmitting Table for more information.			
5	GND	Ground			
6	A	Noninverting Driver Output/Receiver Input			
7	В	Inverting Driver Output/Receiver Input			
8	V _{CC}	Supply Input. Bypass V_{CC} to ground with a $0.1\mu\text{F}$ ceramic capacitor as close to the device as possible.			

Function Tables

Transmitting Table

INPUTS			OUTPUTS			
RE	DE	DI	Α	В		
Х	1	1	1	0		
Х	1	0	0 1			
0	0	Х	High Impedance	High Impedance		
1	0	х	Shutdown. Driver outputs are high impedance			

X = Don't care

Receiving Table

		INPUTS	OUTPUTS		
RE	DE	(V _A - V _B)	Time from Last A-B Transition	RO	
0	Х	≥ +200mV	Always	1	
0	х	-200mV < (V _A - V _B) < +200mV	< t _{D_FS}	Indeterminate RO is latched to previous value	
0	Х	$-50mV < (V_A - V_B) < +50mV$	> t _{D_FS}	1	
0	Х	≤ -200mV	Always	0	
0	Х	Open/Shorted	> t _{D_FS}	1	
1	1	Х	Х	High Impedance	
1	0	Х	х	Shutdown. RO is high impedance	

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Detailed Description

The MAX22506E ESD-protected RS-485/RS-422 transceiver is optimized for high-speed communications up to 50Mbps. This transceiver features integrated hot-swap functionality to eliminate false transitions on the driver during power-up or during a hot-plug event. This transceiver also feature fail-safe receiver inputs, guaranteeing a logic-high on the receiver output when inputs are shorted or open for longer than 10µs (typ).

Receiver Threshold Voltages

The device receiver features a large threshold hysteresis of 250mV (typ) for increased differential noise rejection. Additionally, the receiver features symmetrical threshold voltages. Symmetric thresholds have the advantage that recovered data at the RO output does not have duty-cycle distortion. Typically, fail-safe receivers, which have unipolar (non-symmetric) thresholds, show some duty-cycle distortion at high signal attenuation due to long cable lengths.

Fail-Safe Functionality

The MAX22506E features fail-safe receiver inputs, guaranteeing a logic-high on the receiver output (RO) when the receiver inputs are shorted or open for longer than 10µs (typ). When the differential receiver input voltage is between ± 50 mV, or -50mV $\leq (V_A - V_B) \leq +50$ mV, for more than 10µs (typ), RO is logic-high. For example, in the case of a terminated bus with all transmitters disabled, the receiver differential input voltage is pulled to 0V by the termination resistor, so -50mV $\leq (V_A - V_B) = 0$ V $\leq +50$ mV and RO is guaranteed to be a logic high after 10µs (typ).

Driver Single-Ended Operation

The driver outputs of the MAX22506E can be used in the standard differential operating mode or as single-ended outputs. Because the driver outputs swing rail-to-rail, they can also be used as individual standard TTL or CMOS logic outputs.

Hot-Swap Inputs

Inserting circuit boards into a hot or powered backplane can cause voltage transients on DE, \overline{RE} , and receiver inputs A and B that can lead to data errors. For example, upon initial circuit board insertion, the processor undergoes a power-up sequence. During this period, the high impedance state of the output drivers makes them unable to drive the MAX22506E enable inputs to a defined logic level. Meanwhile, leakage currents of up to 10µA from the high-impedance output or capacitively coupled noise from V_{CC} or GND could cause an input to drift to an incorrect logic state. To prevent such a condition from occurring, the MAX22506E features hot-swap input circuitry on DE and \overline{RE} to safeguard against unwanted driver activation during hot-swap situations. When V_{CC} rises, an internal pulldown circuit holds DE low and \overline{RE} high for at least 10µs. After the initial power-up sequence, the internal pulldown/pullup circuitry becomes transparent, resetting the hot-swap tolerable inputs.

Driver Output Protection

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. The first, a current limit on the output stage, provides immediate protection against short-circuits over the whole common-mode voltage range. The second, a thermal-shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature exceeds +160°C (typ).

Low-Power Shutdown Mode

The MAX22506E features a low-power shutdown mode to reduce supply current when the transceiver is not needed. Pull the \overline{RE} input high and the DE input low to put the device in low-power shutdown mode. If the inputs are in this state for at least 800ns, the parts are guaranteed to enter shutdown. The MAX22506E draws 5µA (max) of supply current when the device is in shutdown.

The $\overline{\text{RE}}$ and DE inputs can be driven simultaneously. The MAX22506E is guaranteed not to enter shutdown if $\overline{\text{RE}}$ is high and DE is low for less than 50ns.

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Integrated ESD Protection

ESD protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the MAX22506E have extra protection against static electricity. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, the MAX22506E is able to keep working without latch-up or damage.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the MAX22506E are characterized for protection to the following limits:

- ±15kV HBM
- ±7kV using the Air-Gap Discharge method specified in IEC 61000-4-2
- ±6kV using the Contact Discharge method specified in IEC 61000-4-2

Human Body Model (HBM)

<u>Figure 9</u> shows the HBM test model, and <u>Figure 10</u> shows the current waveform it generates when discharged into a low-impedance state. This models consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into a test device through a $1.5k\Omega$ resistor.



Figure 9. Human Body ESD Test Model



Figure 10. Human Body Current Waveform

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

IEC 61000-4-2

The IEC 61000-4-2 standard covers ESD testing and performance of finished equipment. However, it does not specifically refer to integrated circuits. The integrated ESD protection circuitry in the transceiver helps in designing equipment to meet IEC 61000-4-2.

The major difference between tests done using the HBM and IEC 61000-4-2 models is the higher peak current in IEC 61000-4-2. This is due to the lower series resistance in the IEC 61000-4-2 model and typically results in the withstand voltage measured to IEC 61000-4-2 being generally lower than that measured using the HBM.

Figure 11 shows the IEC 61000-4-2 model and Figure 12 shows the current waveform for the IEC 61000-4-2 ESD Contact Discharge test.



Figure 11. IEC 61000-4-2 ESD Test Model



Figure 12. IEC 61000-4-2 ESD Generator Current Waveform

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Applications Information

Transceivers on the Bus

The A and B receiver inputs have an input current of 390μ A (max) at 12V and -360μ A (min) at -7V, respectively. According to the RS-485 standard, the relative receiver input resistance can be calculated as 360μ A/ 800μ A = 0.45 unit load (UL). Assuming a line terminated at both ends, up to 71 (= 32UL/0.45UL) MAX22506E transceivers can be used on a multi-drop network. Note that this maximum number of nodes is calculated based on DC criteria only and does not take into consideration signal integrity and transmission line effects at high data rates.

Transient Protection

Transient events that can occur in industrial environments include electrostatic discharge (ESD), surge events (e.g., lightning strikes), and electrical fast transient (EFT) or burst events. Surge pulses typically have a longer duration and higher power-withstand requirements than EFT and ESD strikes. Test requirements and limits for ESD, surge, and burst conditions are included in the IEC 61000-4-2, IEC 61000-4-4, and IEC 6100-4-5 standards.

External ESD Protection

The MAX22506E is internally protected against electrostatic discharge (ESD) events for the levels shown in the Protection section of the *Electrical Characteristics* table. While this internal protection increases the robustness of the device, additional external protection might be required to meet higher ESD limits or to protect against other high-voltage transients in the final application.

Electrical Fast Transient (EFT) Events

The IEC 61000-4-4 standard outlines the voltage levels and duration of an electrical fast transient (EFT) or burst event. EFT is typically a high-frequency, high-voltage burst that is coupled on to the RS-485 cable from external high-voltage switching signals. For example, switching from nearby relays or motors can generate EFT on a RS-485 data line. Relative to surge transient events, EFT bursts generate a small amount of power, but can corrupt data along the line.

To minimize the impact of EFT on signal lines, always use bypass capacitors soldered as close to the IC as possible. Additionally, common-mode chokes and TVS diodes can help to clamp high-voltage transients. Capacitive or resistorcapacitor filters can also be added on the signal lines. Shielded cables, if available, also help to reduce interference from EFT.

Surge Protection

Surge transient events can occur during lightning strikes, for example, and are characterized by the IEC 61000-4-5 standard. Surge events generate high energy, with high voltage peaks and large currents being driven to the driver outputs and receiver inputs.

Per the IEC 61000-4-5 standard, surge pulses must be referenced to protective earth (PE). Isolate PE from the field ground and connect a high-voltage capacitor and a high-voltage resistor between the field ground and PE. Figure 13 shows the current flow through the transceiver and PCB during a surge event. The MAX22506E survived 8/20µs surge testing up to $\pm 2kV/42\Omega$ with a 1000pF high-voltage capacitor without the need for external TVS protection.

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity



Figure 13. Surge Protection

Layout Guidelines

The MAX22506E is designed for robust communication in harsh industrial environments. Use the following guidelines for layout to ensure optimum performance:

- Place the bypass capacitor as close to the $V_{\mbox{CC}}$ pin as possible
- Use supply and ground planes to reduce trace inductance.
- Place external protection (resistors, capacitors, diodes) as close to the device as possible.
- Design protection components directly in the path of the driver output and receiver input signals.

Additionally, pull ground planes away from the RS-485/RS-422 data lines when operating at high data rates to reduce capacitive coupling that can slow edge rates.

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Typical Application Circuits

Half Duplex Point-to-Point Network



Ordering Information

PART	PIN-PACKAGE	PACKAGE CODE
MAX22506EASA+	SOIC8	S8+2C
MAX22506EASA+T	SOIC8	S8+2C
MAX22506EAUA+	μΜΑΧ8	U8+1
MAX22506EAUA+T	μΜΑΧ8	U8+1

+ Denotes lead (Pb)-free/RoHS compliance.

T = Tape and reel.

50Mbps Half-Duplex RS-485/RS-422 Transceiver with High EFT Immunity

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	1/21	Release for Market Intro	—
1	5/21	Updated the <i>General Description,</i> Figure 3, <i>Layout Guidelines,</i> and removed the future product designation from MAX22506EAUA+ and MAX22506EAUA+T in the <i>Ordering Information</i> table	1, 6, 17, 18
2	2/22	Updated Hot-Swap Inputs section	13



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